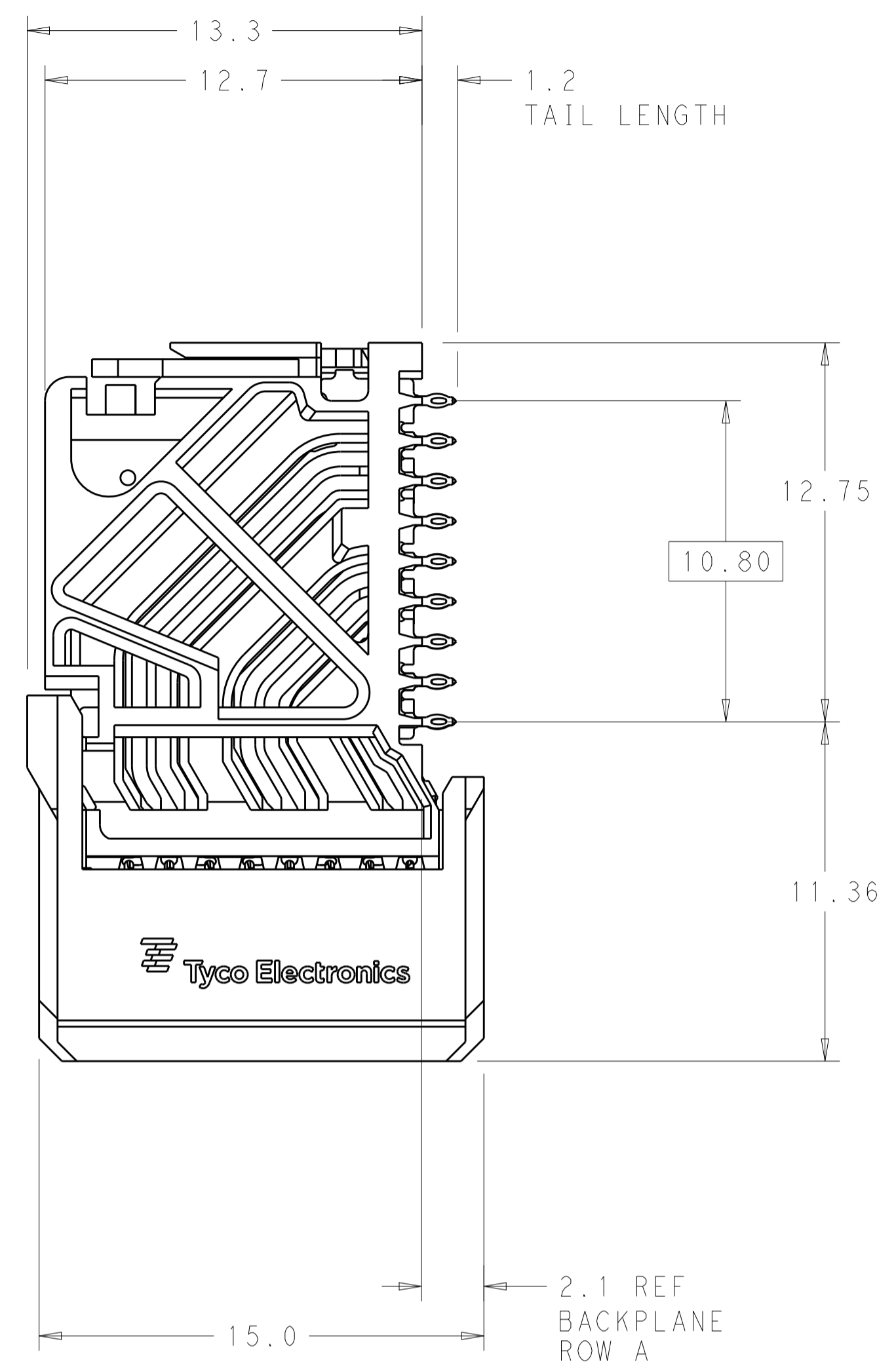
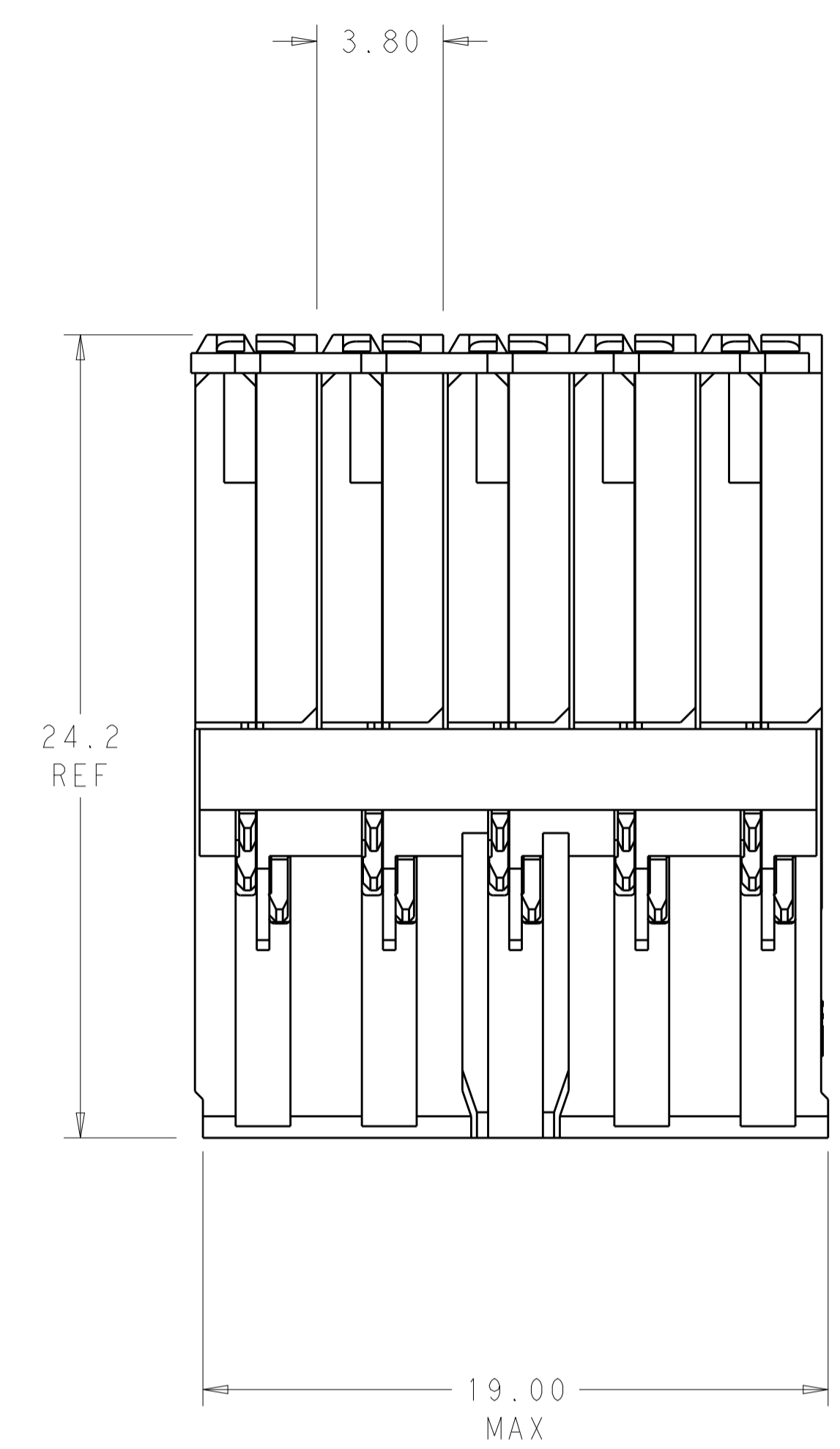
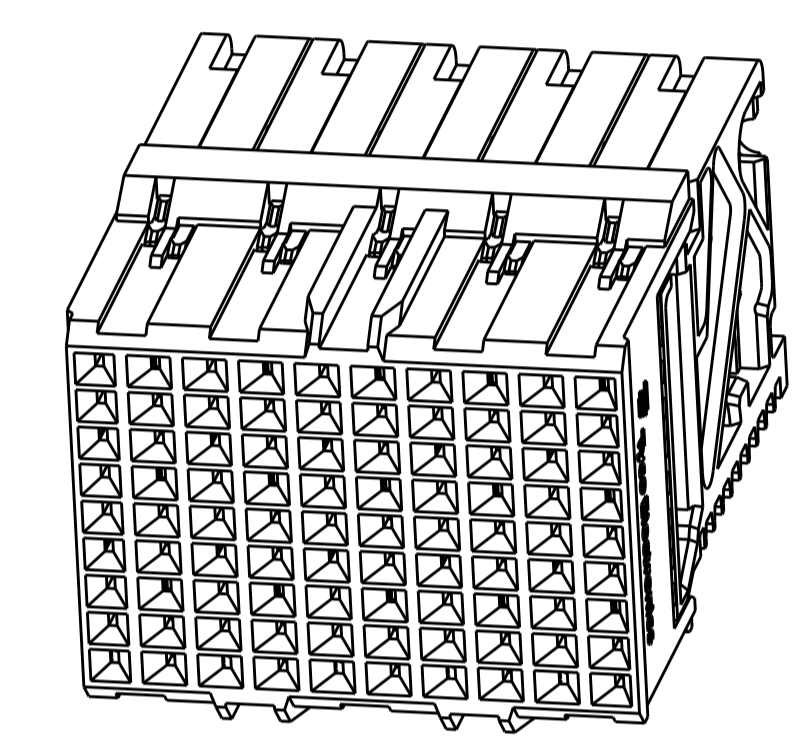


LOC	DIST	REV	DATE	BY	APPV
AD	00	H2	19MAY2017	A.S.	S.Y.

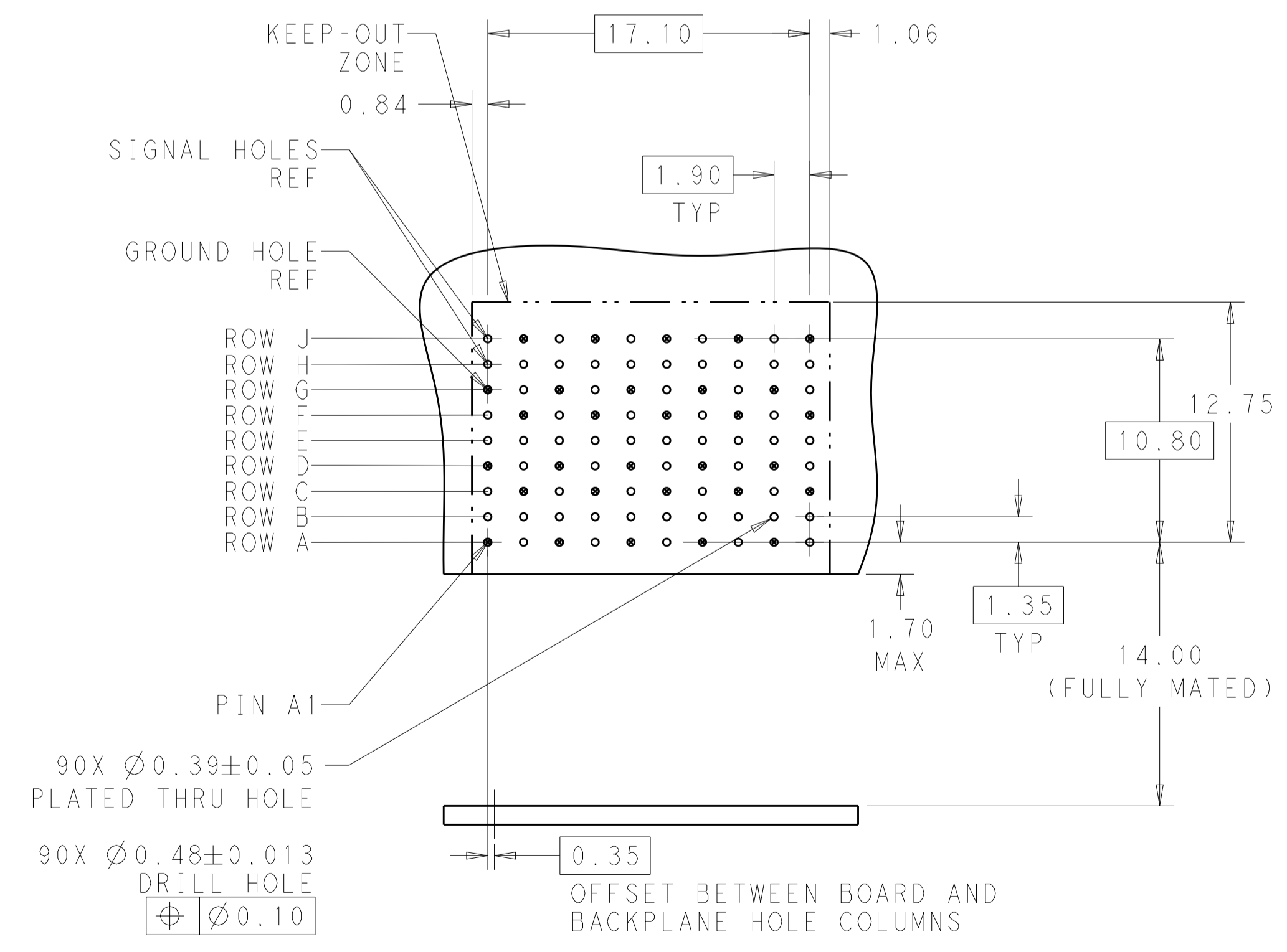
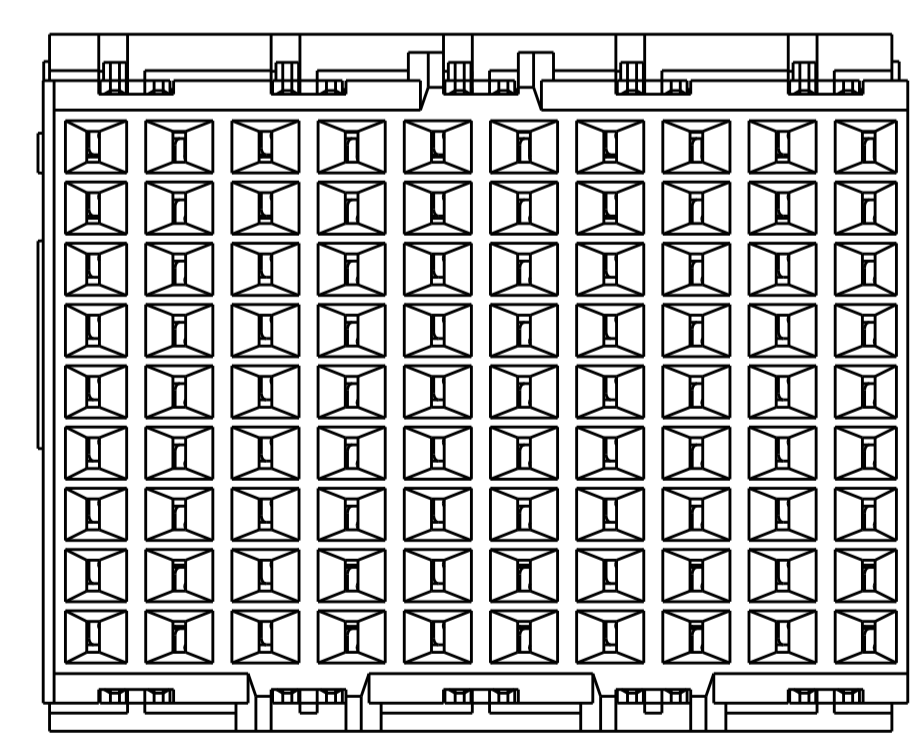


- 1 MATERIAL:
HOUSING: LCP, GLASS FILLED, UL94V-0.
TERMINALS: HIGH PERFORMANCE COPPER ALLOY.
- 2 FINISH:
30μ" SELECTIVE GOLD IN CONTACT AREA. SELECTIVE TIN
ON PCB TAILS, NICKEL OVERALL.
- 3 FINISH :
30μ" SELECTIVE GOLD IN CONTACT AREA. SELECTIVE TIN-LEAD
ON PCB TAILS, NICKEL OVERALL.



SCALE 4:1

REFER TO WWW.TE.COM
FOR PRODUCT AVAILABILITY



90X Ø0.39±0.05
PLATED THRU HOLE

90X Ø0.48±0.013
DRILL HOLE
⊕ Ø0.10

RECOMMENDED PCB LAYOUT
MIN BOARD THICKNESS 1.0

NONE	3	2007705-5
NONE	2	2007705-1
KEY POSITION	FINISH	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN 10FEB2011	TE TE Connectivity	
DIMENSIONS:		CHK D. DIXON 10FEB2011		
mm	TOLERANCES UNLESS OTHERWISE SPECIFIED:	APVD D. DIXON 10FEB2011	NAME IMPACT, 3 PAIR, DAUGHTERCARD 10 COLUMN, UNGUIDED, SIGNAL MODULE, 0.39 EYELET	
Ø	0 PLC ±	PRODUCT SPEC	SIZE CAGE CODE DRAWING NO RESTRICTED TO	
∅	1 PLC ±0.2	APPLICATION SPEC	A100779C=2007705	
∅	2 PLC ±0.13	WEIGHT	SCALE 6:1 SHEET 1 OF 1 REV H2	
∅	3 PLC ±	Customer Drawing		
∅	4 PLC ±			
∅	ANGLES			
∅	FINISH			
∅	SEE TABLE			

单击下面可查看定价，库存，交付和生命周期等信息

[>>TE Connectivity\(泰科\)](#)